

Single N-channel MOSFET

ELM4N6014FDA-N

<http://www.elm-tech.com>

■General description

ELM4N6014FDA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate threshold voltage.

■Features

- $V_{ds}=60V$
- $I_d=20A$
- $R_{ds(on)} = 40m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} = 50m\Omega$ ($V_{gs}=4.5V$)

■Maximum absolute ratings

Tc=25°C. Unless otherwise noted.

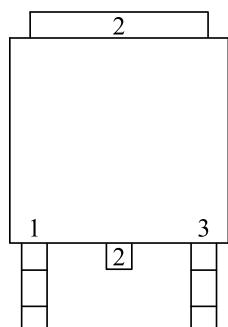
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	Vds	60	V	
Gate-source voltage	Vgs	± 20	V	
Continuous drain current	Id	20	A	1
		13		
Pulsed drain current	Idm	40	A	2
Power dissipation	Pd	31.3	W	3
Storage temperature range	Tstg	-55 to 150	°C	
Operating junction temperature range	Tj	-55 to 150	°C	

■Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Thermal resistance junction-to-case	R θ jc	-	4	°C/W	1
Thermal resistance junction-to-ambient	R θ ja	-	62	°C/W	1

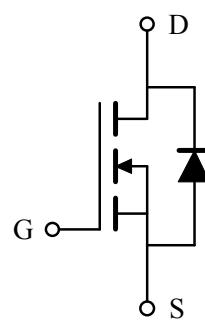
■Pin configuration

TO-252(TOP VIEW)



Pin No.	Pin name
1	GATE
2	DRAIN
3	SOURCE

■Circuit



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■Electrical characteristics

T_j=25°C. Unless otherwise noted.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250µA, Vgs=0V	60	-	-	V	
Drain-source leakage current	Idss	Vds=48V, Vgs=0V	-	-	1	µA	
		Vds=48V, Vgs=0V, Ta=55°C	-	-	5		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V	-	-	±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250µA	1.0	-	2.5	V	
Static drain-source on-resistance	Rds(on)	Vgs=10V, Id=15A	-	33	40	mΩ	2
		Vgs=4.5V, Id=7A	-	40	50		
Forward transconductance	Gfs	Vds=5V, Id=15A	-	25.3	-	S	
Diode forward voltage	Vsd	Is=1A, Vgs=0V	-	-	1.2	V	2
Max. body-diode continuous current	Is	Vgs=Vds=0V, Force current	-	-	20	A	1
Pulsed body-diode current	Ism		-	-	40	A	2
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=15V, f=1MHz	-	1027	-	pF	
Output capacitance	Coss		-	65	-	pF	
Reverse transfer capacitance	Crss		-	46	-	pF	
Gate resistance	Rg	Vds=0V, Vgs=0V, f=1MHz	-	2.5	-	Ω	
SWITCHING PARAMETERS							
Total gate charge (10V)	Qg	Vgs=10V, Vds=48V, Id=15A	-	19.0	-	nC	
Gate-source charge	Qgs		-	2.5	-	nC	
Gate-drain charge	Qgd		-	5.0	-	nC	
Turn-on delay time	td(on)	Vgs=10V, Vds=30V, Id=15A Rgen=3.3Ω	-	2.8	-	ns	
Turn-on rise time	tr		-	16.6	-	ns	
Turn-off delay time	td(off)		-	21.2	-	ns	
Turn-off fall time	tf		-	5.6	-	ns	
Reverse recovery time	trr	If=15A, di/dt=100A/µs	-	12.2	-	ns	
Reverse recovery charge	Qrr		-	7.3	-	nC	

NOTE :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300µs and duty cycle ≤ 2%.
3. The power dissipation is limited by 150°C junction temperature.
4. The data is theoretically the same as Id and Idm, in real applications, should be limited by total power dissipation.

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■Typical characteristics

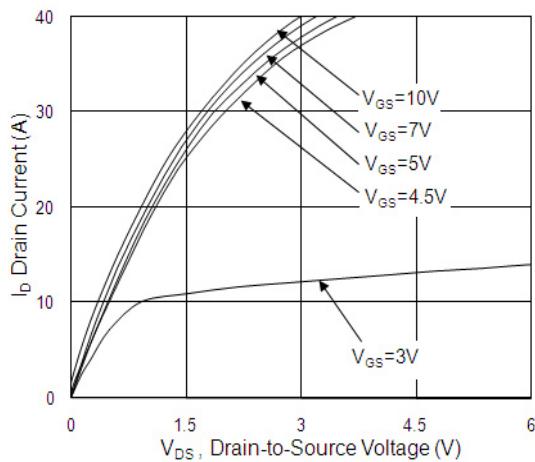


Fig.1 Typical Output Characteristics

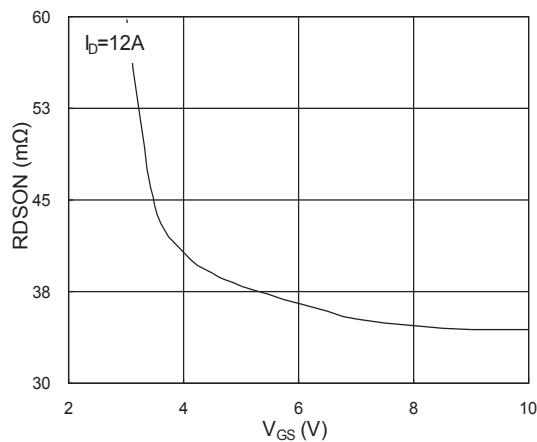


Fig.2 On-Resistance vs. Gate-Source

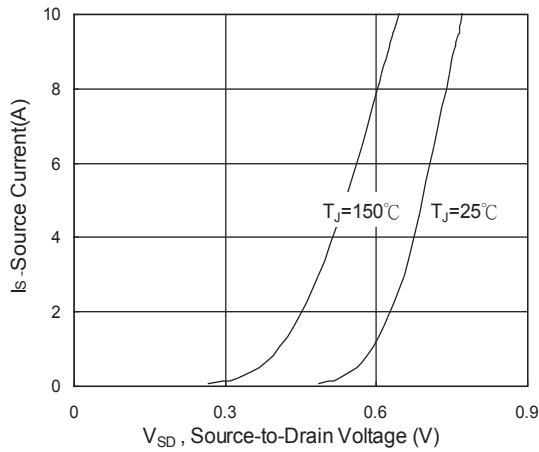


Fig.3 Forward Characteristics Of Reverse

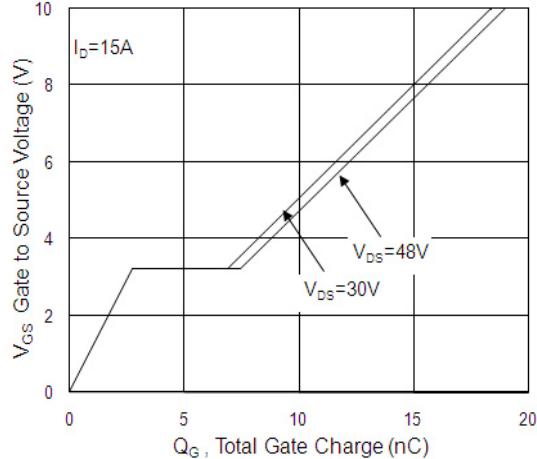


Fig.4 Gate-Charge Characteristics

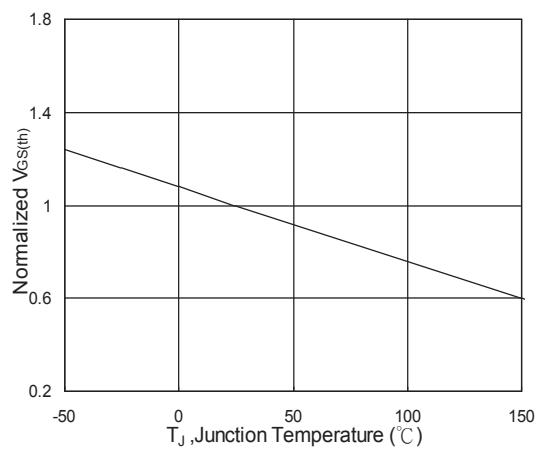


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

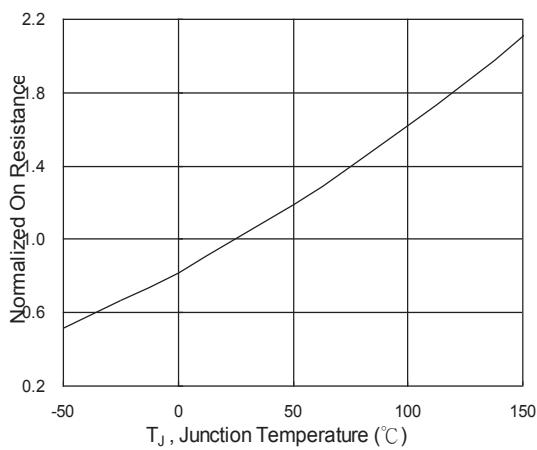


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

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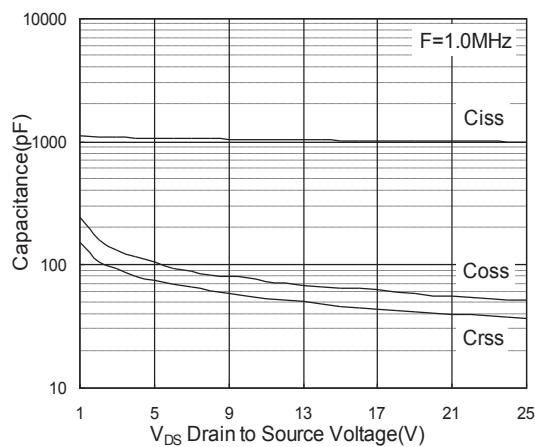


Fig.7 Capacitance

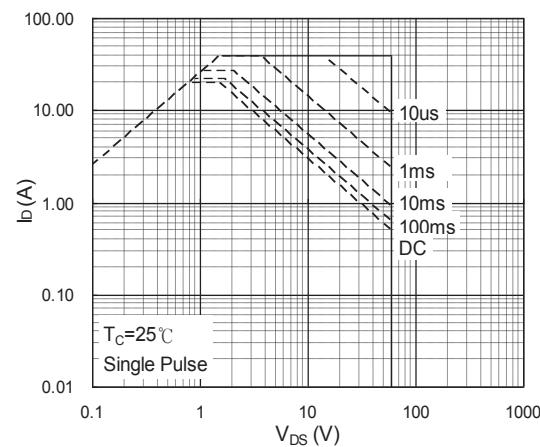


Fig.8 Safe Operating Area

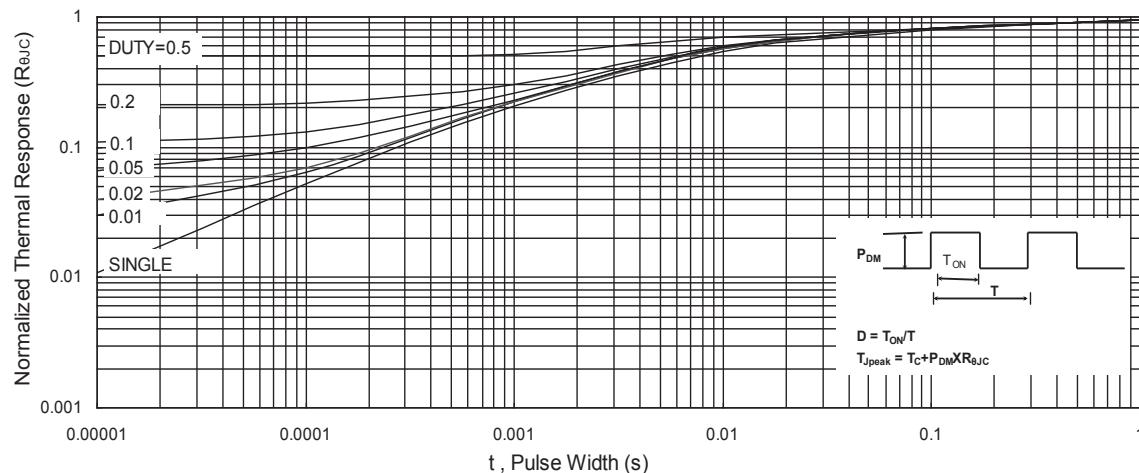


Fig.9 Normalized Maximum Transient Thermal Impedance

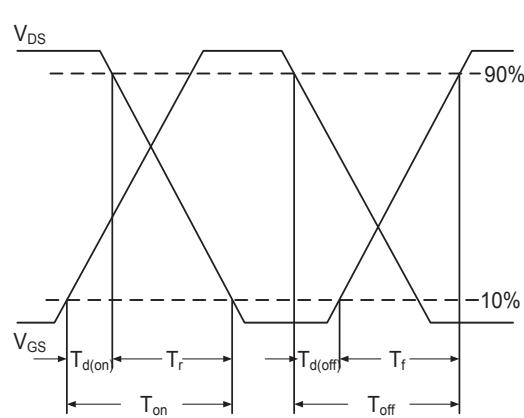


Fig.10 Switching Time Waveform

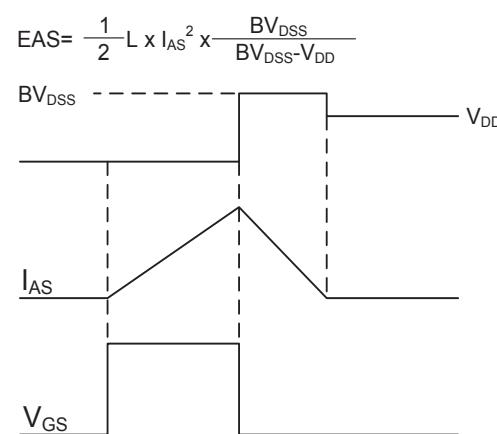


Fig.11 Unclamped Inductive Switching Waveform